ECEN689: Special Topics in High-Speed Links Circuits and Systems Spring 2010

Lecture 21: Crosstalk



Sam Palermo Analog & Mixed-Signal Center Texas A&M University

Announcements

- HW6 will be posted today and due Wednesday April 7
- Exam 2 will be either April 28 or 30
- Reading
 - Dally 6.1-6.3

Agenda

Common noise sources

- Crosstalk
- ISI

Common Noise Sources

- Power supply noise
- Receiver offset
- Crosstalk
- Inter-symbol interference
- Random noise

Crosstalk

- Crosstalk is noise induced by one signal (aggressor) that interferes with another signal (victim)
- Main crosstalk sources
 - Coupling between on-chip (capacitive) wires
 - Coupling between off-chip (t-line/channel) wires
 - Signal return coupling
- Crosstalk is a proportional noise source
 - Cannot be reduced by scaling signal levels
 - Addressed by using proper signal conventions, improving channel and supply network, and using good circuit design and layout techniques

Crosstalk to Capacitive Lines

- On-chip wires have significant capacitance to adjacent wires both on same metal layer and adjacent vertical layers
- Floating victim
 - Examples: Sample-nodes, domino logic
 - When aggressor switches
 - Signal gets coupled to victim via a capacitive voltage divider
 - Signal is not restored



Crosstalk to Driven Capacitive Lines

 Crosstalk to a driven line will decay away with a time-constant

 $\tau_{xc} = R_O (C_C + C_O)$

• Peak crosstalk is inversely proportional to aggressor transition times, t_r , and driver strength $(1/R_0) \Delta V_B(t) =$



Ideal Unit Step :

$$\Delta V_B(t) = k_c \exp\left(-\frac{t}{\tau_{xc}}\right)$$

Step with Finite Rise Time, t_r :

$$= \begin{cases} k_c \left(\frac{\tau_{xc}}{t_r}\right) \left[1 - \exp\left(-\frac{t}{\tau_{xc}}\right)\right] & \text{if } t < t_r \\ k_c \left(\frac{\tau_{xc}}{t_r}\right) \left[\exp\left(-\frac{t - t_r}{\tau_{xc}}\right) - \exp\left(-\frac{t}{\tau_{xc}}\right)\right] & \text{if } t \ge t_r \end{cases}$$

Capacitive Crosstalk Delay Impact

- Aggressor transitioning near victim transition can modulate the victim's effective load capacitance
- This modulates the victim signal's delay, resulting in deterministic jitter



Mitigating Capacitive (On-Chip) Crosstalk

- Adjacent vertical metal layers should be routed perpendicular (Manhattan routing)
- Limit maximum parallel routing distance
- Avoid floating signals and use keeper transistors with dynamic logic
- Maximize signal transition time
 - Trade-off with jitter sensitivity
- For differential signals, periodically "twist" routing to make cross-talk common-mode
- Separate sensitive signals
- Use shield wires
- Couple DC signals to appropriate supply

Transmission Line Crosstalk

• 2 coupled lines:



Transient voltage signal on A is coupled to B capacitively

$$\frac{dV_B(x,t)}{dt} = k_{cx} \frac{dV_A(x,t)}{dt} \quad \text{where} \quad k_{cx} = \frac{C_C}{C_S + C_C}$$

• Transient current signal on A is coupled to B through mutual inductance

$$\frac{\partial I_A(x,t)}{\partial t} = -\frac{\partial V_A(x,t)}{L\partial x}$$
$$\frac{d V_B(x,t)}{d x} = -M \frac{d I_A(x,t)}{d t} = \frac{M}{L} \left[\frac{d V_A(x,t)}{d x} \right] = k_{lx} \frac{d V_A(x,t)}{d x} \quad \text{where} \quad \boxed{k_{lx} = \frac{M}{L}}$$

Near- and Far-End Crosstalk



Off-Chip Crosstalk

- Occurs mostly in package and boardto-board connectors
- FEXT is attenuated by channel response and has band-pass characteristic
- NEXT directly couples into victim and has high-pass characteristic



Signal Return Crosstalk

- Shared return path with finite impedance
- Return currents induce crosstalk occurs among signals



$$V_{xr} = \Delta V \frac{Z_R}{Z_0} = k_{xr} \Delta V$$

Common Noise Sources

- Power supply noise
- Receiver offset
- Crosstalk
- Inter-symbol interference
- Random noise

Inter-Symbol Interference (ISI)



By Linearity: $y^{(0)}(t) = -1^* y^{(1)}(t)$

Peak Distortion Analysis Example



Next Time

- Noise Sources
- Timing Noise
- BER Analysis Techniques